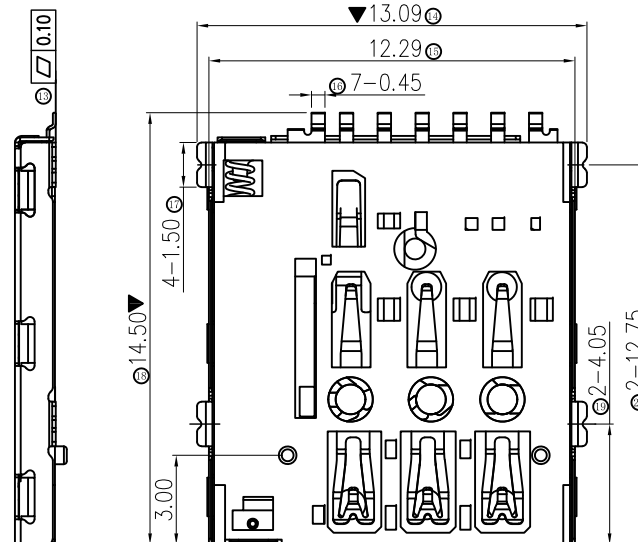
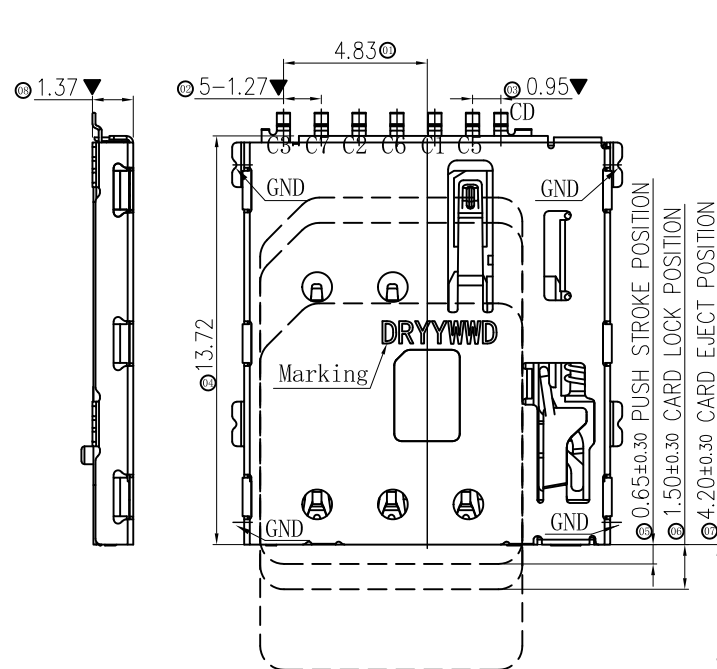
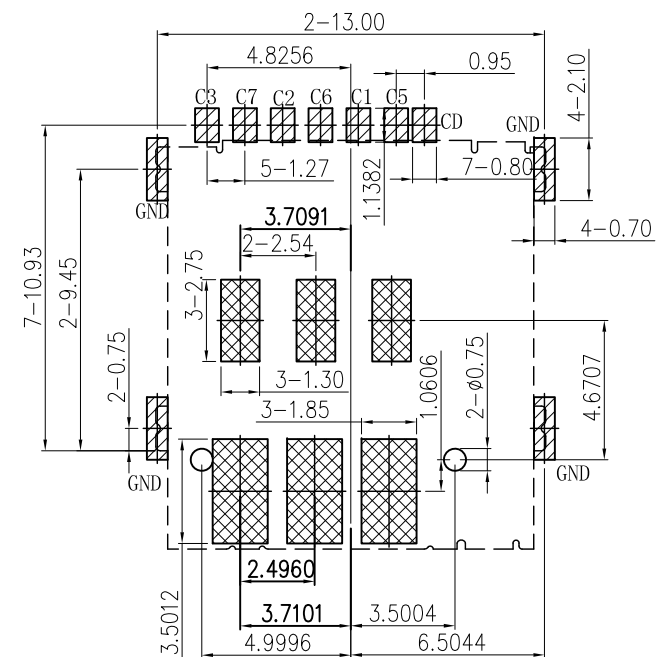


卡片尺寸
1:2



RECOMMENDED PCB LAYOUT
TOLERANCE: ± 0.05

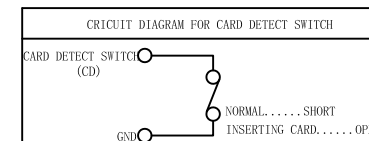
▨ SMT SOLDER AREA

▨ COPPER RESTRICTED AREA
1. TOUCH AREA OF CONTACT
TIPS NO ELECTRICAL FUNCTION
2. NO FIRST PCB LAYOUT
CIRCUITS IN THE AREA

Notes:

- Material:
Housing: High Temperature Thermoplastic
Terminal: Copper Alloy
Shell: Stainless Steel
- Plating:
Terminal: 50u" Ni Underplated Overall
G/F Plated On Contact Area
G/F Plated On Solder Area
Shell: 30u" Ni Underplated Overall
G/F Plated On Contact Area And Solder Area
- Technical Speciality:
Rated Voltage: 30V
Current Rating: 0.5A
Insulation Resistance: 1000MΩ Min.
Contact Resistance: 100mΩ Max.
Withstanding Voltage: 500V DC For 1 Minutes.
Operating Temperature: -40°C ~ +75°C Humidity 80% R.H Max.

PIN/NO	ASSIGNMENT
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O
CD	Detect Switch



REV.	ECN. NO.	DRAWN	DATE	EC.content
A.0	NEW	Candy	06/20/2025	-



HSF
Compliant

⊗: QUALITY CONTROL ITEM		GENERAL TOLERANCE	
APPROVED		.X±0.3	X'±2'
CHECKED		.XX±0.2	X'±1'
DRAWN		.XXX±0.1	

PART NO.: WK-3055-40-1

TITLE:
1.37H Push-Push Nano-SIM卡座

UNIT: mm	SCALE: 1:1	SHEET: 1/1	REV.: A.0
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說明: △: 備註 ◇: 版本變更 ①: 尺寸序號 ■: 重點尺寸 ▼: CPK尺寸

DOCUMENT NO.: ZER0013/A.3